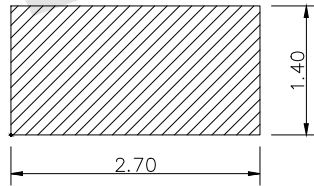
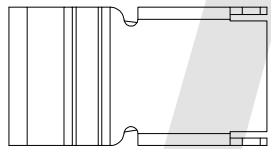
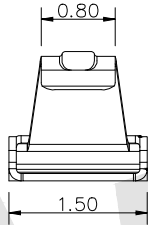
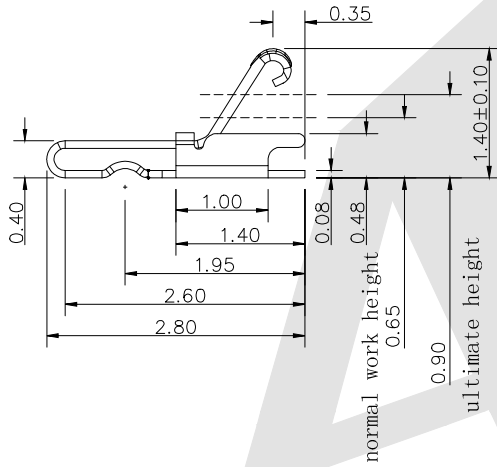
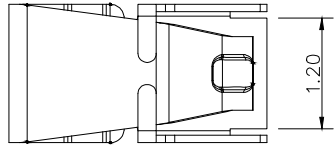
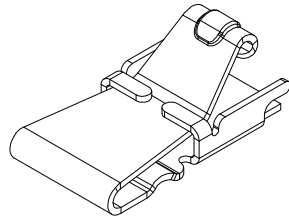


HSF



ROHS



RECOMMENDED PCB LAYOUT

Notes:

1: Material:

Spring: BeCu(C1720)

2: Plating:

Spring:50~80u' Ni

Contact area:1u' Au over 50~80u' Ni

3: Electrical:

Rated Current&Voltage:DC 1A, 12V

Contact Resistance: 50 mΩ Max. at working height.

4: Mechanical:

Force: 60~80g at working height.

Durability: 1000 cycles (min)

5: Work Temperature:

Withstanding Highest Temperature: 280°C

Operational Temperature:-20°C~ + 70°C

SF - 028 - X - X - 16  
 ① ② ③ ④ ⑤

① Series No.:

SF:Spring Finger

② Length:

028:2.8mm

③ Packing Method:

A:Tray R:Tape & Reel B:Bag

④ Plating

A:1u" Au Plated over 50~80u Ni

B:3u" Au Plated over 50~80u Ni

C:Sn Plated over Ni

⑤ Serial Number:

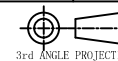
16

Unless Otherwise specified tolerance  
 X. ±0.35 X.XX:±0.20  
 X.X:±0.25 X.XXX:±0.15

SCALE: As Shown UNIT: mm

DRAW ZLA DATE 01/04/2022

CHECK BobYang DATE 01/04/2022



**Antenk** ANTENK ELECTRONICS CO., LTD  
 Http://www.antenk.com  
 E-mail:sales@antenk.com

TITLE:  
 Spring Finger L=2.8MM

DRAWING NO: SF-028-X-X-16

PRODUCT NO: SF-028-X-X-16

REV DESCRIPTION

DATE

1 2 3 4 5 6 7 8